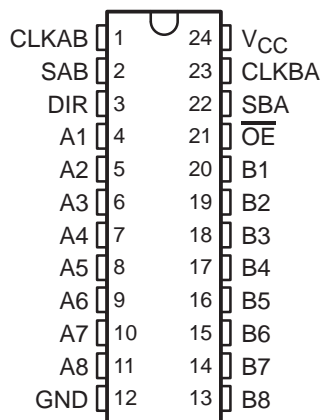


# SN54LVTH646, SN74LVTH646 3.3-V ABT OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

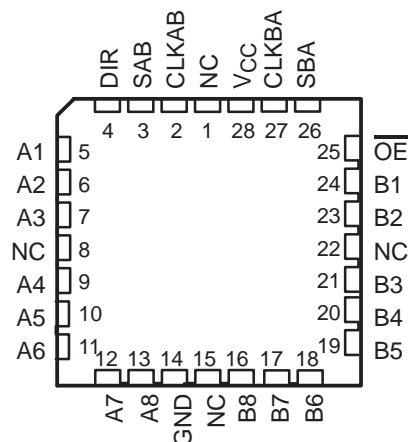
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- Support Mixed-Mode Signal Operation (5-V Input and Output Voltages With 3.3-V  $V_{CC}$ )
- Support Unregulated Battery Operation Down to 2.7 V
- Typical  $V_{OLP}$  (Output Ground Bounce)  $<0.8$  V at  $V_{CC} = 3.3$  V,  $T_A = 25^\circ\text{C}$
- $I_{off}$  and Power-Up 3-State Support Hot Insertion
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Latch-Up Performance Exceeds 500 mA Per JESD 17
- ESD Protection Exceeds JESD 22
  - 2000-V Human-Body Model (A114-A)
  - 200-V Machine Model (A115-A)

SN54LVTH646 . . . JT OR W PACKAGE  
SN74LVTH646 . . . DB, DGV, DW, NS, OR PW PACKAGE  
(TOP VIEW)



SN54LVTH646 . . . FK PACKAGE  
(TOP VIEW)



NC – No internal connection

## description/ordering information

These bus transceivers and registers are designed specifically for low-voltage (3.3-V)  $V_{CC}$  operation, but with the capability to provide a TTL interface to a 5-V system environment.

## ORDERING INFORMATION

$T_A$	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	SOIC – DW	Tube	SN74LVTH646DW	LVTH646
		Tape and reel	SN74LVTH646DWR	
	SOP – NS	Tape and reel	SN74LVTH646NSR	LVTH646
	SSOP – DB	Tape and reel	SN74LVTH646DBR	LXH646
	TSSOP – PW	Tube	SN74LVTH646PW	LXH646
		Tape and reel	SN74LVTH646PWR	
–55°C to 125°C	TVSOP – DGV	Tape and reel	SN74LVTH646DGV	LXH646
	CDIP – JT	Tube	SNJ54LVTH646JT	SNJ54LVTH646JT
	CFP – W	Tube	SNJ54LVTH646W	SNJ54LVTH646W
	LCCC – FK	Tube	SNJ54LVTH646FK	SNJ54LVTH646FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

**3.3-V ABT OCTAL BUS TRANSCEIVERS AND REGISTERS  
WITH 3-STATE OUTPUTS**

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**description/ordering information (continued)**

The 'LVTH646 devices consist of bus transceiver circuits, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 illustrates the four fundamental bus-management functions that can be performed with the 'LVTH646.

Output-enable ( $\overline{OE}$ ) and direction-control (DIR) inputs are provided to control the transceiver functions. In the transceiver mode, data present at the high-impedance port can be stored in either register or in both.

The select-control (SAB and SBA) inputs can multiplex stored and real-time (transparent mode) data. The direction control (DIR) determines which bus receives data when  $\overline{OE}$  is low. In the isolation mode ( $\overline{OE}$  high), A data can be stored in one register and/or B data can be stored in the other register.

When an output function is disabled, the input function is still enabled and can be used to store and transmit data. Only one of the two buses, A or B, can be driven at a time.

Active bus-hold circuitry is provided to hold unused or floating data inputs at a valid logic level. Use of pullup or pulldown resistors with the bus-hold circuitry is not recommended.

When  $V_{CC}$  is between 0 and 1.5 V, the devices are in the high-impedance state during power up or power down. However, to ensure the high-impedance state above 1.5 V,  $\overline{OE}$  should be tied to  $V_{CC}$  through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

These devices are fully specified for hot-insertion applications using  $I_{off}$  and power-up 3-state. The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the devices when they are powered down. The power-up 3-state circuitry places the outputs in the high-impedance state during power up and power down, which prevents driver conflict.

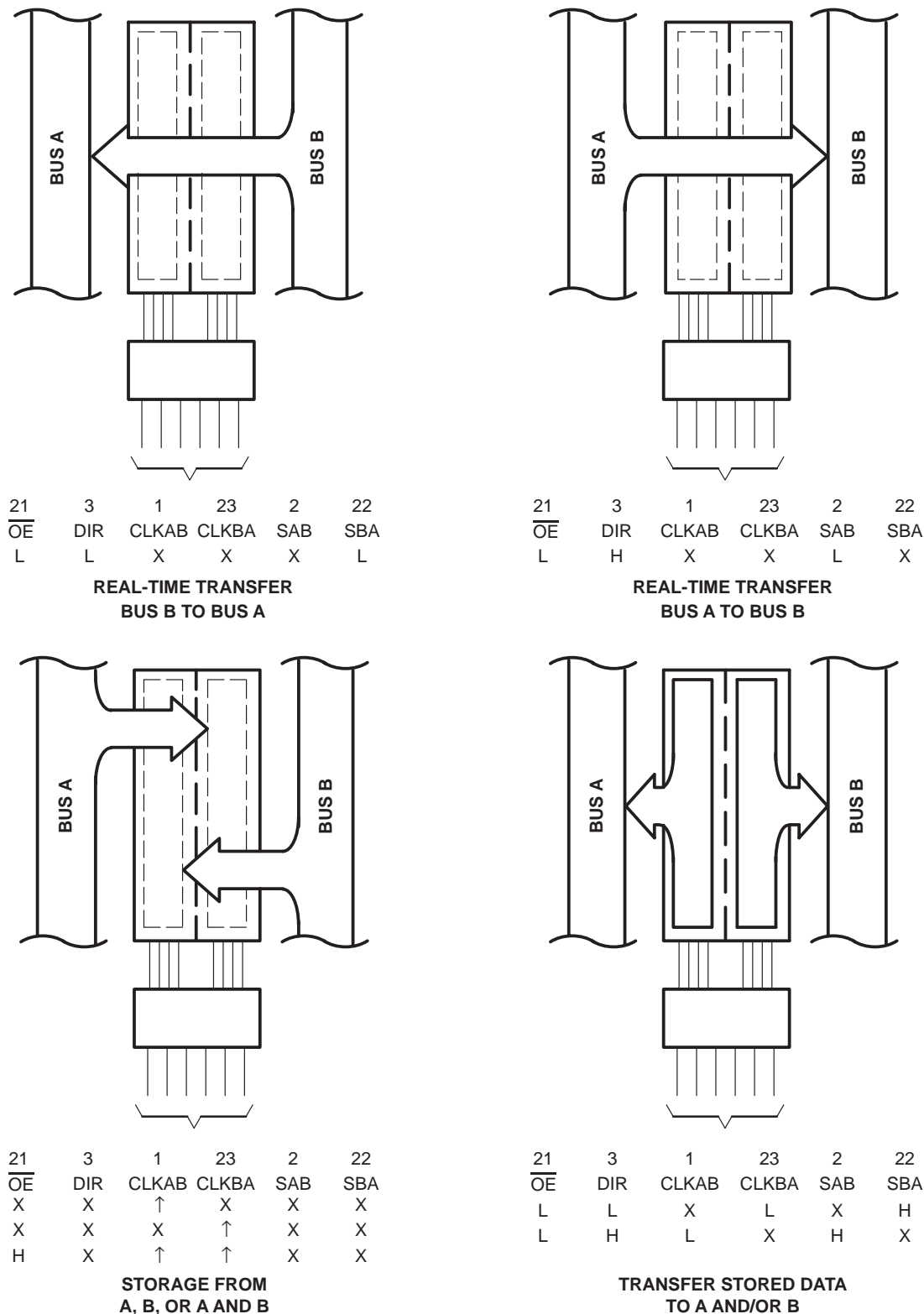
**FUNCTION TABLE**

INPUTS						DATA I/Os		OPERATION OR FUNCTION
$\overline{OE}$	DIR	CLKAB	CLKBA	SAB	SBA	A1–A8	B1–B8	
X	X	↑	X	X	X	Input	Unspecified†	Store A, B unspecified†
X	X	X	↑	X	X	Unspecified†	Input	Store B, A unspecified†
H	X	↑	↑	X	X	Input	Input	Store A and B data
H	X	H or L	H or L	X	X	Input disabled	Input disabled	Isolation, hold storage
L	L	X	X	X	L	Output	Input	Real-time B data to A bus
L	L	X	H or L	X	H	Output	Input	Stored B data to A bus
L	H	X	X	L	X	Input	Output	Real-time A data to B bus
L	H	H or L	X	H	X	Input	Output	Stored A data to B bus

† The data-output functions can be enabled or disabled by various signals at  $\overline{OE}$  and DIR. Data-input functions always are enabled; i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.

# SN54LVTH646, SN74LVTH646 3.3-V ABT OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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Pin numbers shown are for the DB, DGV, DW, JT, NS, PW, and W packages.

Figure 1. Bus-Management Functions

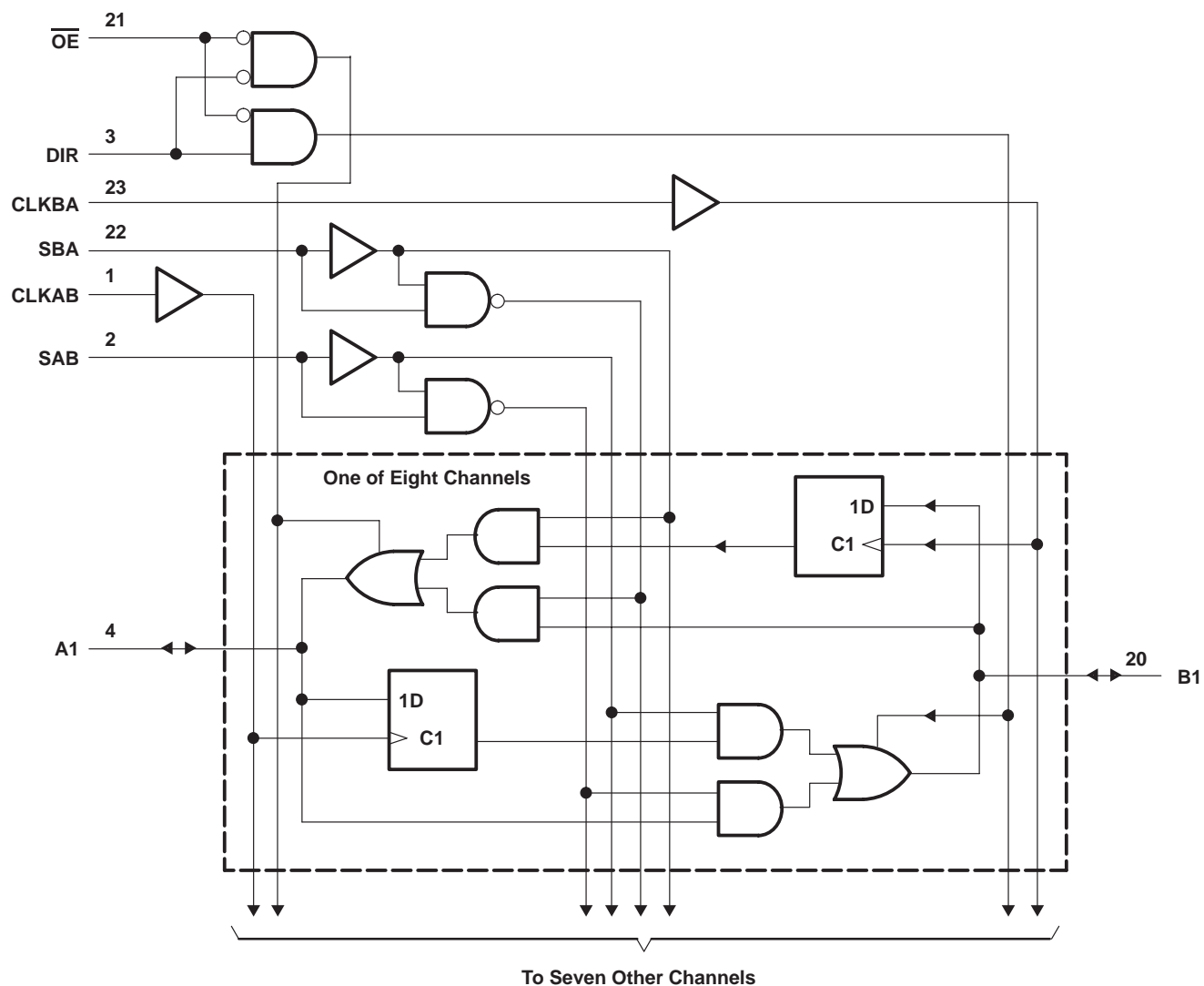
# SN54LVTH646, SN74LVTH646

## 3.3-V ABT OCTAL BUS TRANSCEIVERS AND REGISTERS

### WITH 3-STATE OUTPUTS

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#### logic diagram (positive logic)



Pin numbers shown are for the DB, DGV, DW, JT, NS, PW, and W packages.

## SCBS705G – AUGUST 1997 – REVISED OCTOBER 2003

Supply voltage range, $V_{CC}$	.....	-0.5 V to 4.6 V
Input voltage range, $V_I$ (see Note 1)	.....	-0.5 V to 7 V
Voltage range applied to any output in the high-impedance or power-off state, $V_O$ (see Note 1)	.....	-0.5 V to 7 V
Voltage range applied to any output in the high state, $V_O$ (see Note 1)	.....	-0.5 V to $V_{CC} + 0.5$ V
Current into any output in the low state, $I_O$ : SN54LVTH646	.....	96 mA
SN74LVTH646	.....	128 mA
Current into any output in the high state, $I_O$ (see Note 2): SN54LVTH646	.....	48 mA
SN74LVTH646	.....	64 mA
Input clamp current, $I_{IK}$ ( $V_I < 0$ )	.....	-50 mA
Output clamp current, $I_{OK}$ ( $V_O < 0$ )	.....	-50 mA
Package thermal impedance, $\theta_{JA}$ (see Note 3): DB package	.....	63°C/W
DGV package	.....	86°C/W
DW package	.....	46°C/W
NS package	.....	65°C/W
PW package	.....	88°C/W
Storage temperature range, $T_{sta}$	.....	-65°C to 150°C

NOTES:

1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. This current flows only when the output is in the high state and  $V_O > V_{CC}$ .
3. The package thermal impedance is calculated in accordance with JESD 51-7.

			SN54LVTH646		SN74LVTH646		UNIT
			MIN	MAX	MIN	MAX	
V <sub>CC</sub>	Supply voltage		2.7	3.6	2.7	3.6	V
V <sub>IH</sub>	High-level input voltage		2		2		V
V <sub>IL</sub>	Low-level input voltage		0.8		0.8		V
V <sub>I</sub>	Input voltage		5.5		5.5		V
I <sub>OH</sub>	High-level output current		−24		−32		mA
I <sub>OL</sub>	Low-level output current		48		64		mA
Δt/Δv	Input transition rise or fall rate	Outputs enabled	10		10		ns/V
Δt/ΔV <sub>CC</sub>	Power-up ramp rate		200		200		μs/V
T <sub>A</sub>	Operating free-air temperature		−55	125	−40	85	°C



# SN54LVTH646, SN74LVTH646

## 3.3-V ABT OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		SN54LVTH646			SN74LVTH646			UNIT
				MIN	TYP†	MAX	MIN	TYP†	MAX	
V <sub>IK</sub>		V <sub>CC</sub> = 2.7 V, I <sub>I</sub> = −18 mA		−1.2			−1.2			V
V <sub>OH</sub>		V <sub>CC</sub> = 2.7 V to 3.6 V, I <sub>OH</sub> = −100 μA		V <sub>CC</sub> −0.2			V <sub>CC</sub> −0.2			V
		V <sub>CC</sub> = 2.7 V, I <sub>OH</sub> = −8 mA		2.4			2.4			
		V <sub>CC</sub> = 3 V		I <sub>OH</sub> = −24 mA						
				I <sub>OH</sub> = −32 mA			2			
V <sub>OL</sub>		V <sub>CC</sub> = 2.7 V		I <sub>OL</sub> = 100 μA			0.2			V
				I <sub>OL</sub> = 24 mA			0.5			
		V <sub>CC</sub> = 3 V		I <sub>OL</sub> = 16 mA			0.4			
				I <sub>OL</sub> = 32 mA			0.5			
				I <sub>OL</sub> = 48 mA			0.55			
				I <sub>OL</sub> = 64 mA			0.55			
I <sub>I</sub>	Control inputs	V <sub>CC</sub> = 3.6 V, V <sub>I</sub> = V <sub>CC</sub> or GND		±1			±1			μA
		V <sub>CC</sub> = 0 or 3.6 V, V <sub>I</sub> = 5.5 V		10			10			
	A or B ports‡	V <sub>CC</sub> = 3.6 V		V <sub>I</sub> = 5.5 V			20			
				V <sub>I</sub> = V <sub>CC</sub>			1			
				V <sub>I</sub> = 0			−5			
I <sub>off</sub>		V <sub>CC</sub> = 0, V <sub>I</sub> or V <sub>O</sub> = 0 to 4.5 V					±100			μA
I <sub>I(hold)</sub>	A or B ports	V <sub>CC</sub> = 3 V		V <sub>I</sub> = 0.8 V			75			μA
				V <sub>I</sub> = 2 V			−75			
		V <sub>CC</sub> = 3.6 V§, V <sub>I</sub> = 0 to 3.6 V					±500			
I <sub>OZPU</sub>		V <sub>CC</sub> = 0 to 1.5 V, V <sub>O</sub> = 0.5 V to 3 V, OE = don't care		±100			±100			μA
I <sub>OZPD</sub>		V <sub>CC</sub> = 1.5 V to 0, V <sub>O</sub> = 0.5 V to 3 V, OE = don't care		±100			±100			μA
I <sub>CC</sub>		V <sub>CC</sub> = 3.6 V, I <sub>O</sub> = 0, V <sub>I</sub> = V <sub>CC</sub> or GND		Outputs high			0.19			mA
				Outputs low			5			
				Outputs disabled			0.19			
ΔI <sub>CC</sub> ¶		V <sub>CC</sub> = 3 V to 3.6 V, One input at V <sub>CC</sub> − 0.6 V, Other inputs at V <sub>CC</sub> or GND		0.2			0.2			mA
C <sub>i</sub>		V <sub>I</sub> = 3 V or 0		4			4			pF
C <sub>io</sub>		V <sub>O</sub> = 3 V or 0		9			9			pF

† All typical values are at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

‡ Unused terminals at  $V_{CC}\text{ or GND}$

§ This is the bus-hold maximum dynamic current. It is the minimum overdrive current required to switch the input from one state to another.

¶ This is the increase in supply current for each input that is at the specified TTL voltage level, rather than  $V_{CC}\text{ or GND}$ .

# SN54LVTH646, SN74LVTH646

## 3.3-V ABT OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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timing requirements over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

			SN54LVTH646				SN74LVTH646				UNIT
			$V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$		$V_{CC} = 2.7\text{ V}$		$V_{CC} = 3.3\text{ V} \pm 0.3\text{ V}$		$V_{CC} = 2.7\text{ V}$		
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
f <sub>clock</sub>	Clock frequency		150		150		150		150		MHz
t <sub>w</sub>	Pulse duration, CLK high or low		3.3		3.3		3.3		3.3		ns
t <sub>su</sub>	Setup time, A or B before CLKAB↑ or CLKBA↑	Data high	1.3		1.6		1.2		1.5		ns
		Data low	1.9		2.6		1.6		2.2		
t <sub>h</sub>	Hold time, A or B after CLKAB↑ or CLKBA↑		1.2		1.2		0.8		0.8		ns

switching characteristics over recommended operating free-air temperature range,  $C_L = 50\text{ pF}$  (unless otherwise noted) (see Figure 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	SN54LVTH646				SN74LVTH646				UNIT	
			V <sub>CC</sub> = 3.3 V ± 0.3 V		V <sub>CC</sub> = 2.7 V		V <sub>CC</sub> = 3.3 V ± 0.3 V			V <sub>CC</sub> = 2.7 V		
			MIN	MAX	MIN	MAX	MIN	TYP†	MAX	MIN		MAX
f <sub>max</sub>			150		150		150			150		MHz
t <sub>PLH</sub>	CLKBA or CLKAB	A or B	1    5.3		5.9		1.8    3.1    4.7		5.6		ns	
t <sub>PHL</sub>			1.5    5		5.9		1.8    3.1    4.7		5.6			
t <sub>PLH</sub>	A or B	B or A	1    4.9		5.6		1.3    2.3    3.5		4.1		ns	
t <sub>PHL</sub>			1.2    4.8		5		1.3    2.4    3.5		4.1			
t <sub>PLH</sub>	SBA or SAB‡	A or B	1    5.3		6.3		1.5    3    4.9		6		ns	
t <sub>PHL</sub>			1.3    5.3		6.3		1.5    3.3    4.9		6			
t <sub>PZH</sub>	OE	A or B	1    5.4		6.7		1.1    3.1    5.2		6.5		ns	
t <sub>PZL</sub>			1    5.6		6.7		1.1    3.4    5.2		6.5			
t <sub>PHZ</sub>	OE	A or B	1.7    6.3		6.5		2.3    3.9    5.5		6.1		ns	
t <sub>PLZ</sub>			2.2    6.3		6.5		2.3    4    5.5		5.9			
t <sub>PZH</sub>	DIR	A or B	1.2    5.6		6.8		1.3    3.4    5.2		6.6		ns	
t <sub>PZL</sub>			1.2    6.7		6.8		1.3    3.6    5.2		6.6			
t <sub>PHZ</sub>	DIR	A or B	1.1    7.2		8.1		1.5    3.2    5.6		6.7		ns	
t <sub>PLZ</sub>			1.4    6.1		6.6		1.5    3.8    5.6		6.3			

$\dagger$  All typical values are at  $V_{CC} = 3.3\text{ V}$ ,  $T_A = 25^\circ\text{C}$ .

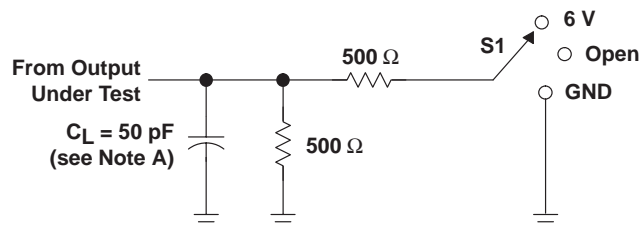
$\ddagger$  These parameters are measured with the internal output state of the storage register opposite that of the bus input.

# SN54LVTH646, SN74LVTH646

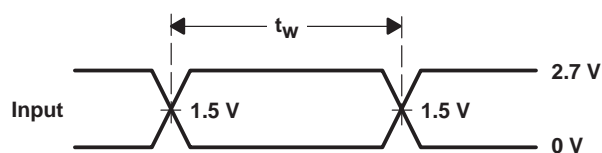
## 3.3-V ABT OCTAL BUS TRANSCEIVERS AND REGISTERS WITH 3-STATE OUTPUTS

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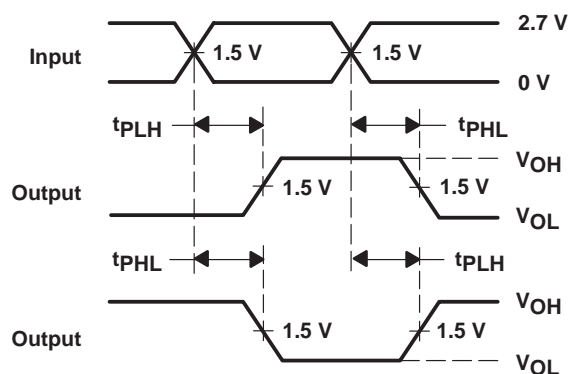
### PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT

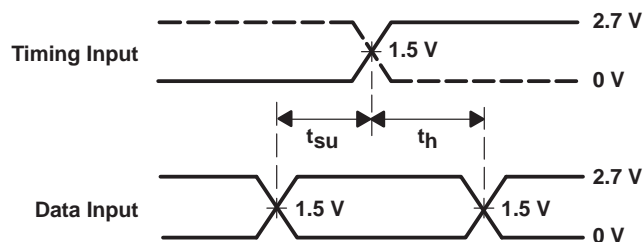


VOLTAGE WAVEFORMS  
PULSE DURATION

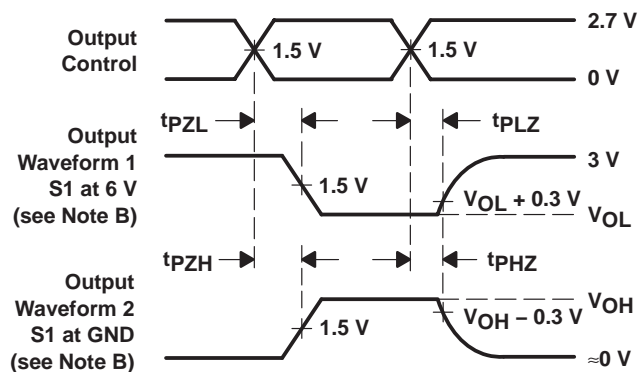


VOLTAGE WAVEFORMS  
PROPAGATION DELAY TIMES  
INVERTING AND NONINVERTING OUTPUTS

TEST	S1
$t_{PLH}/t_{PHL}$	Open
$t_{PLZ}/t_{PZL}$	6 V
$t_{PHZ}/t_{PZH}$	GND



VOLTAGE WAVEFORMS  
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS  
ENABLE AND DISABLE TIMES  
LOW- AND HIGH-LEVEL ENABLING

- NOTES: A.  $C_L$  includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics:  $PRR \leq 10 \text{ MHz}$ ,  $Z_O = 50 \Omega$ ,  $t_r \leq 2.5 \text{ ns}$ ,  $t_f \leq 2.5 \text{ ns}$ .
- D. The outputs are measured one at a time with one transition per measurement.
- E. All parameters and waveforms are not applicable to all devices.

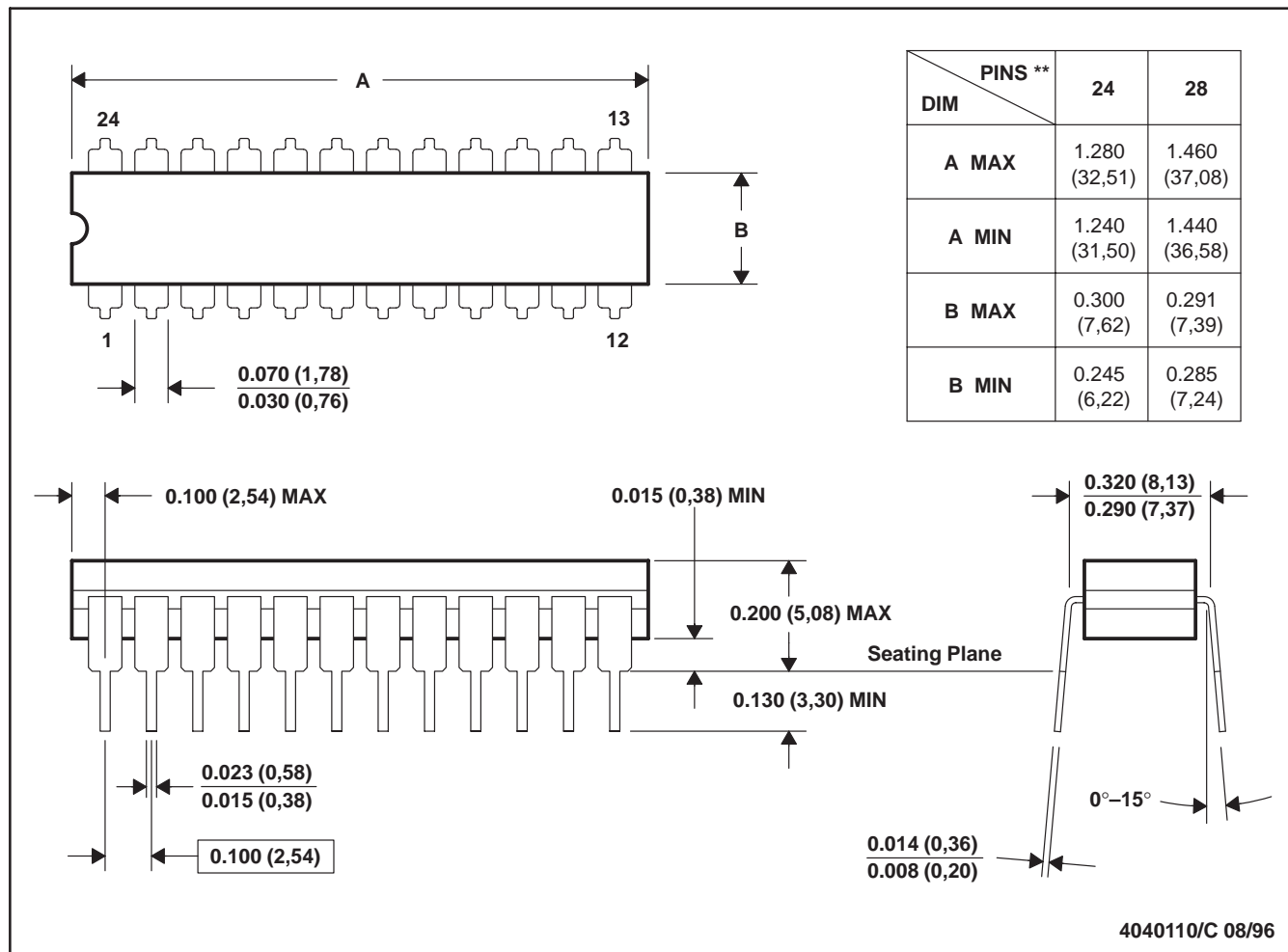
Figure 2. Load Circuit and Voltage Waveforms



## JT (R-GDIP-T\*\*)

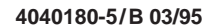
## CERAMIC DUAL-IN-LINE

24 LEADS SHOWN



- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a ceramic lid using glass frit.
  - Index point is provided on cap for terminal identification.
  - Falls within MIL STD 1835 GDIP3-T24, GDIP4-T28, and JEDEC MO-058 AA, MO-058 AB

## CERAMIC DUAL FLATPACK



- 

## FK (S-CQCC-N\*\*)

## LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN

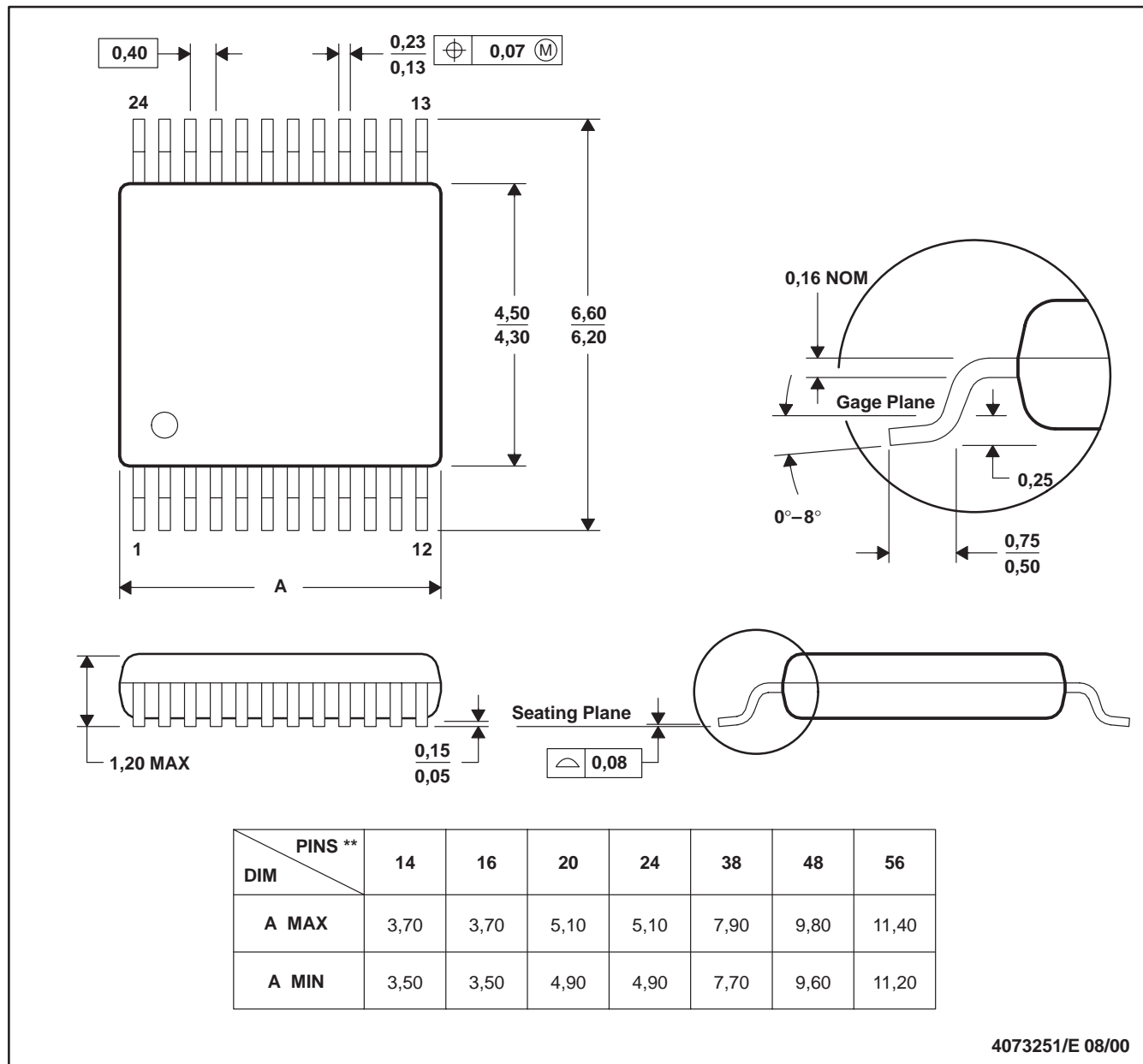


- NOTES:
- All linear dimensions are in inches (millimeters).
  - This drawing is subject to change without notice.
  - This package can be hermetically sealed with a metal lid.
  - The terminals are gold plated.
  - Falls within JEDEC MS-004

## DGV (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

24 PINS SHOWN

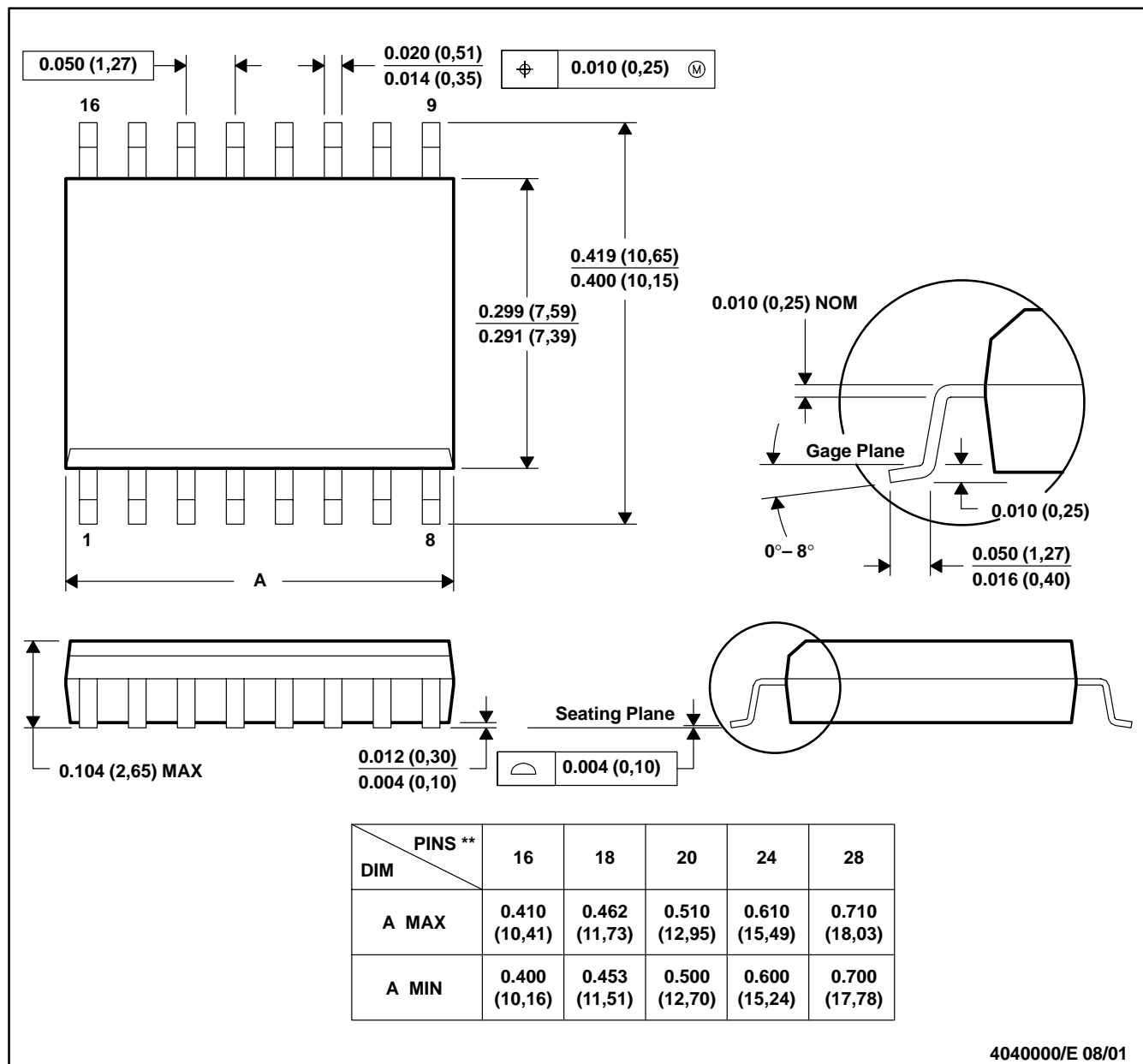


- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.  
 D. Falls within JEDEC: 24/48 Pins – MO-153  
 14/16/20/56 Pins – MO-194

DW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

16 PINS SHOWN



- NOTES: A. All linear dimensions are in inches (millimeters).  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).  
 D. Falls within JEDEC MS-013

# MECHANICAL DATA

NS (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

## DB (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

## PW (R-PDSO-G\*\*)

## PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153



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Amplifiers	<a href="http://amplifier.ti.com">amplifier.ti.com</a>	Audio	<a href="http://www.ti.com/audio">www.ti.com/audio</a>
Data Converters	<a href="http://dataconverter.ti.com">dataconverter.ti.com</a>	Automotive	<a href="http://www.ti.com/automotive">www.ti.com/automotive</a>
DSP	<a href="http://dsp.ti.com">dsp.ti.com</a>	Broadband	<a href="http://www.ti.com/broadband">www.ti.com/broadband</a>
Interface	<a href="http://interface.ti.com">interface.ti.com</a>	Digital Control	<a href="http://www.ti.com/digitalcontrol">www.ti.com/digitalcontrol</a>
Logic	<a href="http://logic.ti.com">logic.ti.com</a>	Military	<a href="http://www.ti.com/military">www.ti.com/military</a>
Power Mgmt	<a href="http://power.ti.com">power.ti.com</a>	Optical Networking	<a href="http://www.ti.com/opticalnetwork">www.ti.com/opticalnetwork</a>
Microcontrollers	<a href="http://microcontroller.ti.com">microcontroller.ti.com</a>	Security	<a href="http://www.ti.com/security">www.ti.com/security</a>
		Telephony	<a href="http://www.ti.com/telephony">www.ti.com/telephony</a>
		Video & Imaging	<a href="http://www.ti.com/video">www.ti.com/video</a>
		Wireless	<a href="http://www.ti.com/wireless">www.ti.com/wireless</a>

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